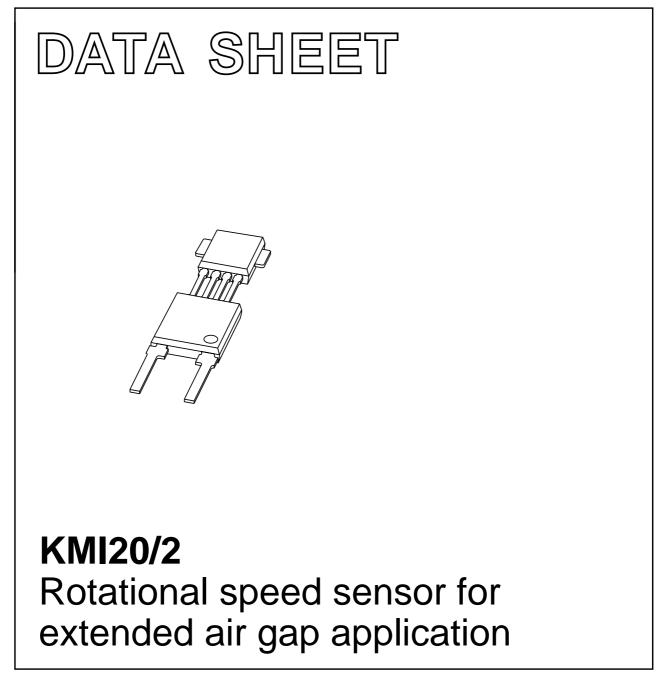
DISCRETE SEMICONDUCTORS



Objective specification

2000 Sep 04



KMI20/2

Rotational speed sensor for extended air gap application

FEATURES

- Digital current output signal
- Digital offset compensation
- Extended air gap
- Zero speed capability
- Wide temperature range
- High tolerance to vibration
- EMC resistant
- Tolerant to positioning.

DESCRIPTION

The KMI20/2 sensor detects rotational speed of magnetized targets⁽¹⁾.

The sensor consists of a magnetoresistive sensor element, a driver IC in BIMOS technology, a digital signal conditioning IC in highly integrated CMOS technology and a ferrite magnet. The frequency of the digital current output signal is proportional to the rotational speed of a magnetized wheel.

CAUTION

Do not press two or more products together against their magnetic forces.

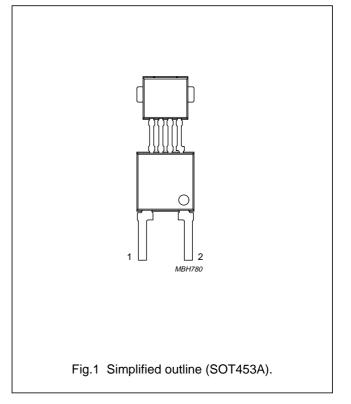
(1) The sensor contains customized integrated circuits. Usage in hydraulic brake systems and in systems with active brake control is forbidden. For all other applications, higher temperature versions of up to 150 °C are available on request.

QUICK REFERENCE DATA

SYMBOL	PARAMETER		TYP.	MAX.	UNIT
V _{CC}	DC supply voltage		12	18	V
I _{CC (low)}	current output signal low		7	8.4	mA
I _{CC (high)}	current output signal high		14	16.8	mA
ft	operating tooth frequency	0	-	2500	Hz
T _{amb}	ambient operating temperature	-40	_	+85	°C

PINNING

PIN	SYMBOL		
1	V _{CC}		
2	V–		



KMI20/2

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CC}	DC supply voltage	$T_{amb} = -40$ to +85 °C; $R_L = 115 \Omega$	0	18	V
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	operating ambient temperature		-40	+85	°C
T _{sld}	soldering temperature	t < 10 s	- 260		°C
	output short-circuit duration to GND	see Fig.7	continuous		
	wrong polarity	$T_{amb} = -40$ to +65 °C, $R_L = 115 \Omega$; note 1	continuous		

Note

1. With $R_L = 115 \Omega$ the device is continuously protected against wrong polarity of the DC supply voltage (V_{CC}) to GND; see Fig.7.

CHARACTERISTICS

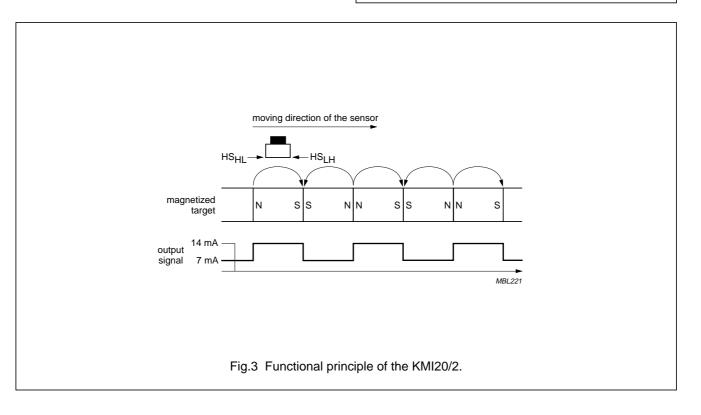
 T_{amb} = 25 °C; V_{CC} = 12 V; test circuit; see Fig.7; R_L = 115 Ω ; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CC (low)}	current output low	-40 to +85 °C; see Fig.6	5.6	7	8.4	mA
I _{CC (high)}	current output high	-40 to +85 °C; see Fig.6	11.2	14	16.8	mA
t _r	output signal rise time	C _L = 100 pF; 10% to 90% value; see Fig.8	-	0.5	-	μs
t _f	output signal fall time	C _L = 100 pF; 90% to 10% value; see Fig.8	-	0.5	-	μs
f _t	operating tooth frequency	for both rotational directions	0	-	2500	Hz
H _{yin 0 Hz}	magnetic hysteresis in initial mode	peak to peak	0.2	0.3	0.4	kA/m
H _{yin(off)}	magnetic offset in initial mode		-0.2	0	+0.2	kA/m
H _{y(act)}	magnetic hysteresis in active mode	percentage of last signal amplitude	30	-	45	%

FUNCTIONAL DESCRIPTION

The KMI20/2 is sensitive to magnetic fields. The functional principle is shown in Fig.3. The field lines of a magnetized target are shown as a straight target (it could also be circular e.g. for rotational speed measurement). The sensor is switched by the magnetic field components Hs_{LH} or Hs_{HL} either to low (7 mA) or to high (14 mA). Oscillation of the sensor is avoided by the implementation of a hysteresis in the signal conditioning circuit. Stability is ensured by the inclusion of a permanent magnet, the continuous magnetic field of which prevents frequency doubling in the sensor.

The KMI20/2 contains a magnetoresistive sensor element and two ICs: a Position Detector IC (PDIC) and a Line Driver IC (LDIC). The sensor signal is fed into the PDIC. The PDIC is the signal conditioning IC which includes A/D and D/A converters and a Schmitt trigger, and provides digital compensation. The LDIC contains two current sources (one constant and one switchable) and a voltage control unit (see Fig.4).



magnet with direction of

magnetization

sensor

IC

Fig.2 Component detail of the KMI20/2.

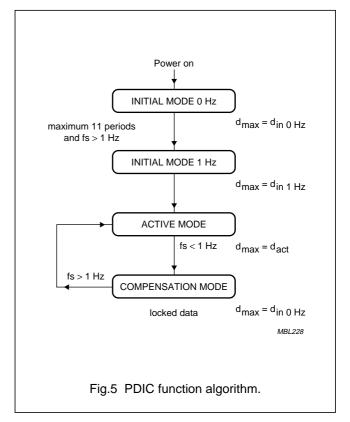
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KMI20/2

CONSTANT CURRENT SOURCE Vcc VOLTAGE CONTROL -(|)-ADJUSTABLE OFFSET SMART SWITCHABLE SENSOR CANCELLATION COMPARATOR AMPLIFIER CURRENT SOURCE ╢ V-Fc = 0 Hz(|)ON-CHIP DIGITAL CONTROL UNIT OSCILLATOR MBL238 Fig.4 Block diagram.

Figure 5 shows the digital compensation function in algorithmic format. After power-on the sensor system is running in INITIAL MODE 0 Hz. The sensor signal is preamplified but not offset compensated. The output signal represents the specified magnetic field strength (see Chapter "Characteristics"), totally speed independent. When there is a magnetic offset the system must first detect the sensor signal amplitudes to compensate for it (INITIAL_MODE_1_Hz). An output signal is produced (first compensation run finished) at the latest after 11 magnetic field pairs with a frequency above 1 Hz have been sensed.

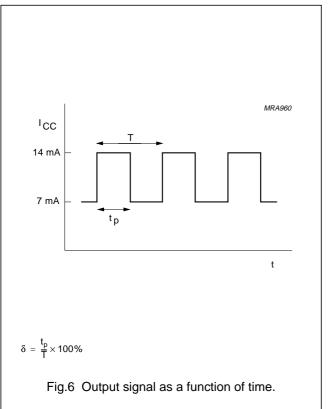
After detecting the fields in initial mode the PDIC changes to ACTIVE MODE. The sensor signal is permanently offset compensated. The hysteresis is now directly dependent on the last magnetic amplitude (30% to 45%, see Chapter "Characteristics") down to typically 50 A/m. Quitting ACTIVE MODE is caused by power off or by decreasing the magnetic field frequency below 1 Hz. The system is locked into COMPENSATION MODE and continues to detect every magnetic field down to zero speed.



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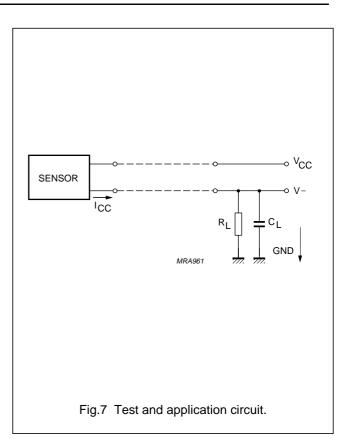


Table 1 EMC test results

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Rotational speed sensor for extended air gap application

EMC

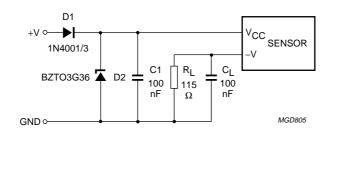
Figure 8 shows a recommended application circuit for automotive applications. It provides a protection interface to meet Electromagnetic Compatibility (EMC) standards and safeguard against voltage spikes. Table 1 lists the tests which are applicable to this circuit and the achieved class of functional status. Protection against 'load dump' (test pulses 5 according to "*DIN 40839*") means a very high demand on the protection circuit and requires a suitable suppressor diode with sufficient energy absorption capability.

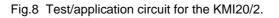
The board net often contains a central load dump protection that makes such a device in the protection circuit of the sensor module unnecessary.

Tests for Electrostatic Discharge (ESD) were conducted in line with *"MIL Std. 883D, Method 3015.7"* to demonstrate the KMI20/2's handling capabilities. The test conditions were: C = 150 pF, R = 150 Ω and V = 4 kV.

Electromagnetic disturbances with fields up to 150 V/m and f = 1 GHz (ref. "*DIN 40839*") have no influence on performance.

EMC REF. DIN 40839	SYMBOL	MIN. (V)	MAX. (V)	REMARKS	CLASS
Test pulse 1	V _{LD}	-100	-	t _d = 2 ms	С
Test pulse 2	V _{LD}	-	100	t _d = 0.2 ms	A
Test pulse 3a	V _{LD}	-150	-	t _d = 0.1 μs	A
Test pulse 3b	V _{LD}	-	100	t _d = 0.1 μs	A
Test pulse 4	V _{LD}	-7	-	t _d = 130 ms	В
Test pulse 5	V _{LD}	-	120	t _d = 400 ms	В

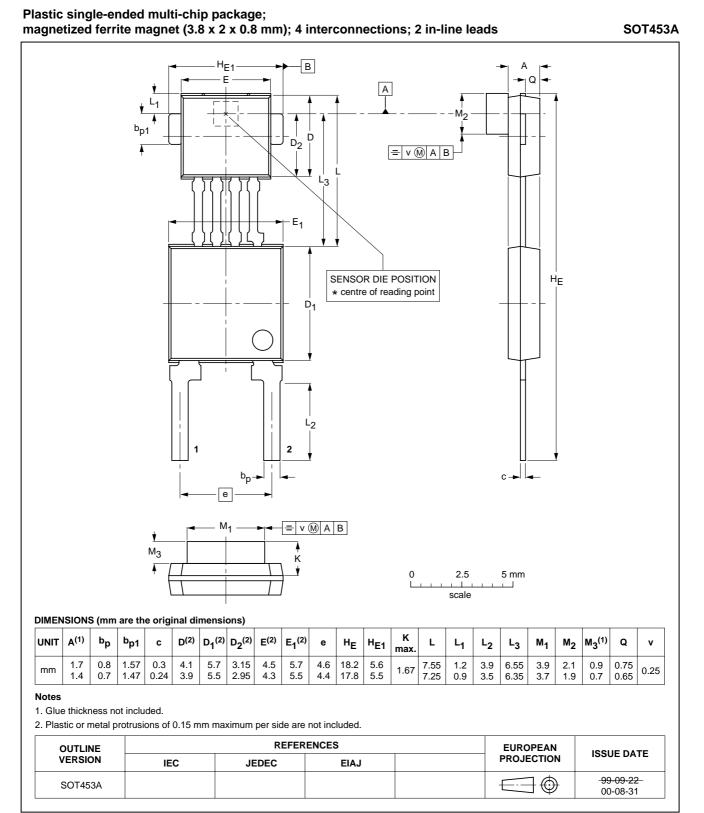




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PACKAGE OUTLINE



KMI20/2

DATA SHEET STATUS

DATA SHEET STATUS	PRODUCT STATUS	DEFINITIONS ⁽¹⁾
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

Note

1. Please consult the most recently issued data sheet before initiating or completing a design.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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